

# Fibers Desizing Updates

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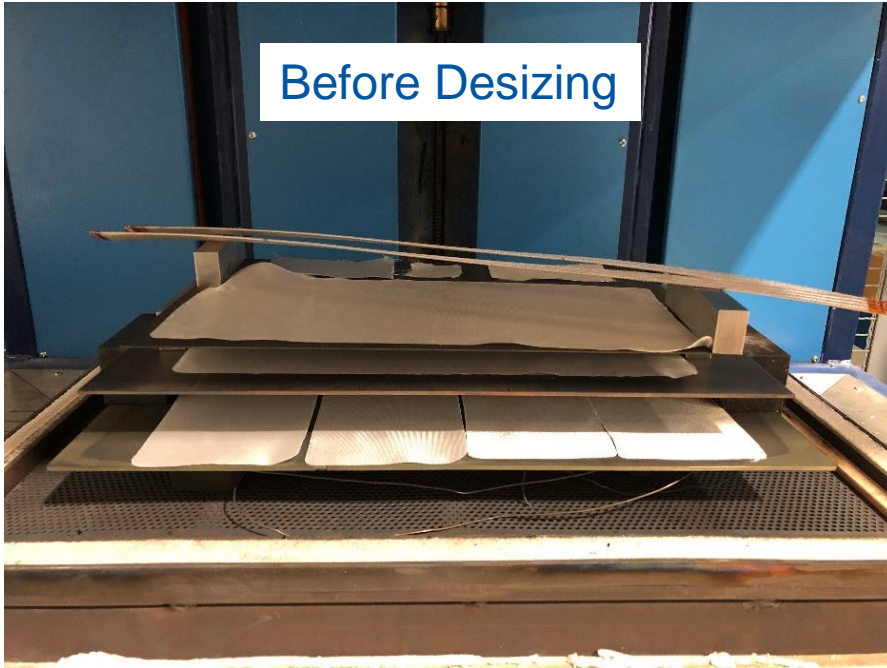
4/19/2024

# Summary of Experiments/Tests

1. Thermal Desizing + Reaction Cycle (48h at 650C in Ar)
  - Making plates for **electrical tests** (S2 Glass, Quartzel)
  - Study of cable **conductor oxidation** during thermal desizing
2. Plasma Desizing + Reaction Cycle (48h at 650C in Ar)
  - **Parameter** Study (Distance, time, intensity)
  - Plates for **electrical tests**

# Thermal Desizing Process

400C for 4h in air, 50C per hour ramp rate.



## Starting from top:

Layer 1:

- 2 Insulated MQXF Cables S2 Glass 933

Layer 2:

- 1 200mmx400mm tissue S2 Glass 636 11 Tex
- 2 tissues of S2 Glass 636 11 Tex for TGA
- 1 tissues of S2 Glass 493 66 Tex for TGA

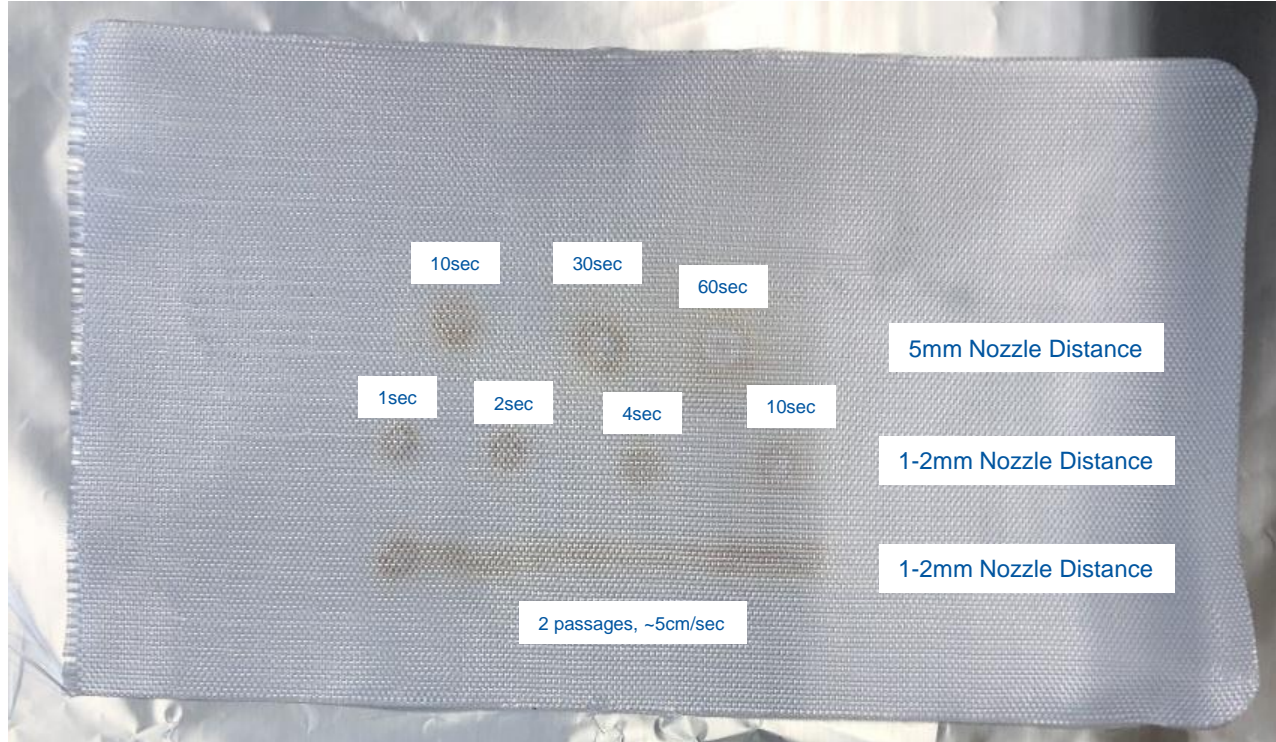
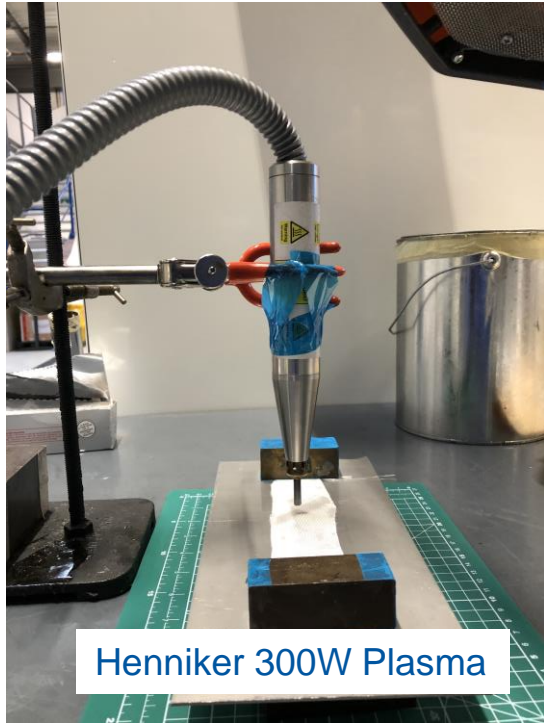
Layer 3:

- 1 200mmx400mm tissue S2 Glass 493 66 Tex

Layer 4:

- Left: 2 tissues 120mmx300mm S2 Glass 493 66 Tex
- Right: 2 tissues 120mmx300mm Quartzel QS1318 Sizing 33 Tex

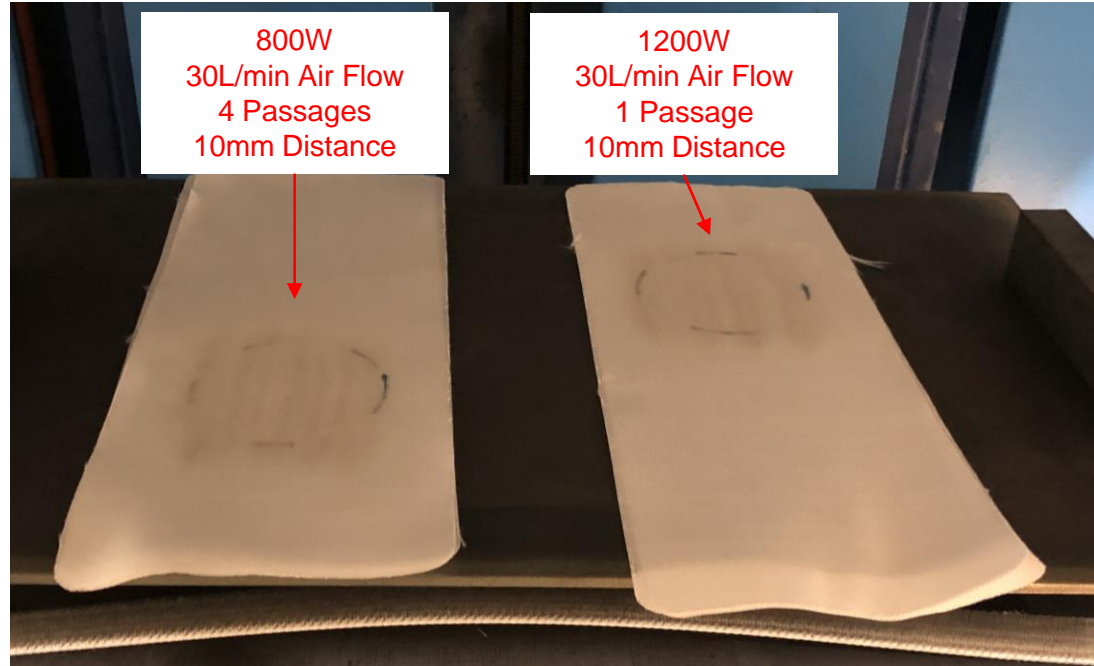
# Plasma Desizing Parameter Study



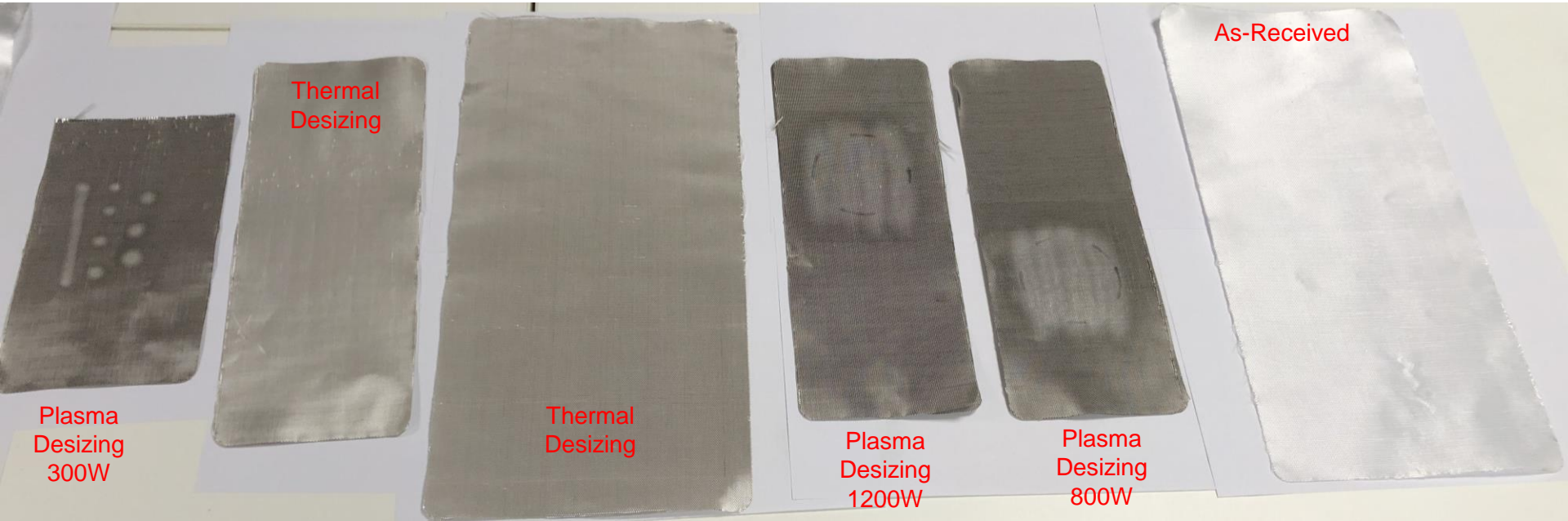
# Plasma Desizing Parameter Study



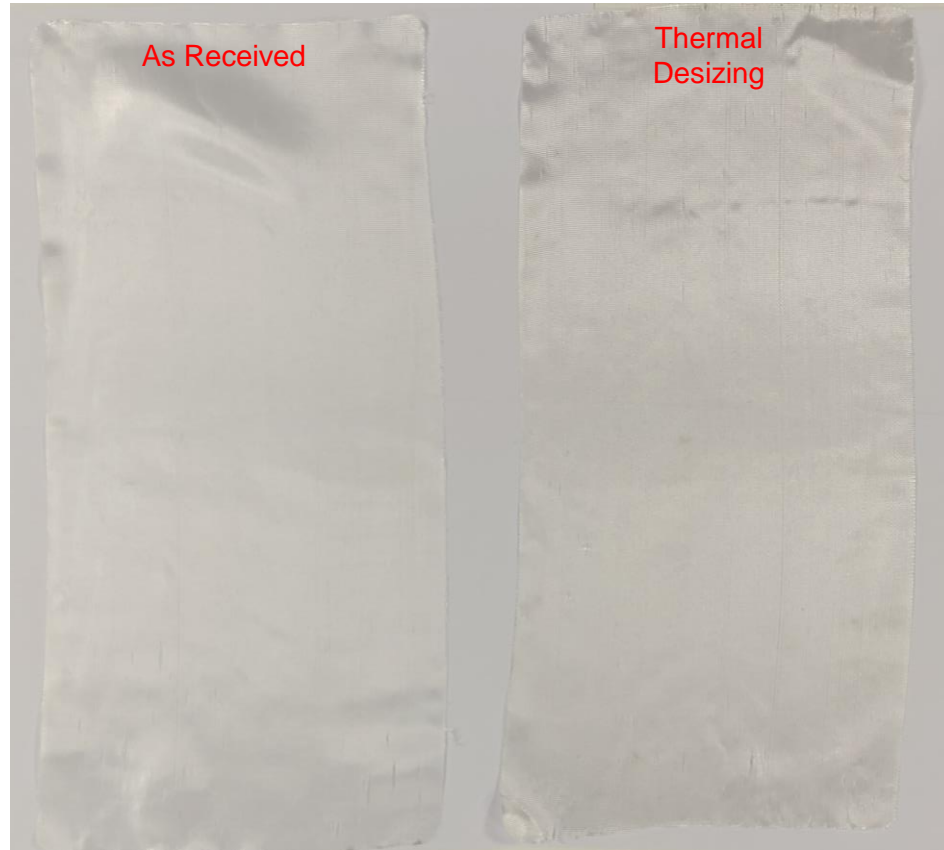
AcXys ULS Nano 1200W Plasma



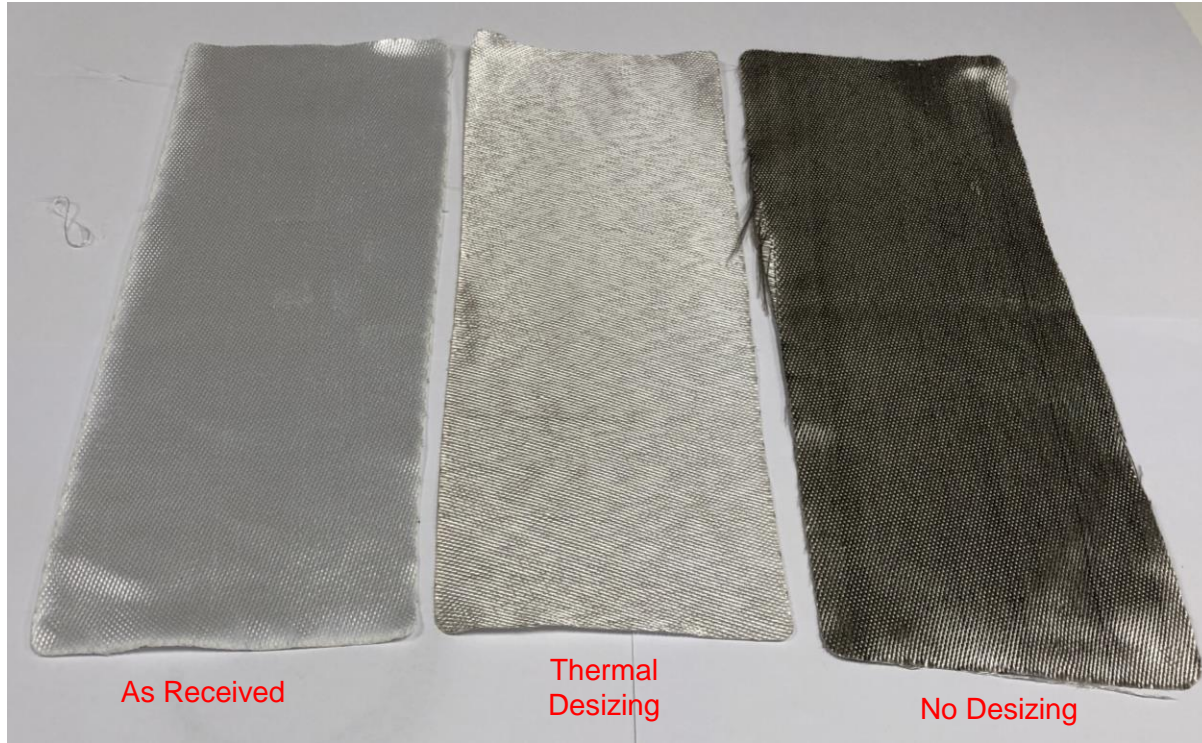
# S2 Glass 493 Sizing 66 Tex



# S2 Glass 636 Sizing 11 Tex



# Quartzel QS1318 sizing 33 Tex





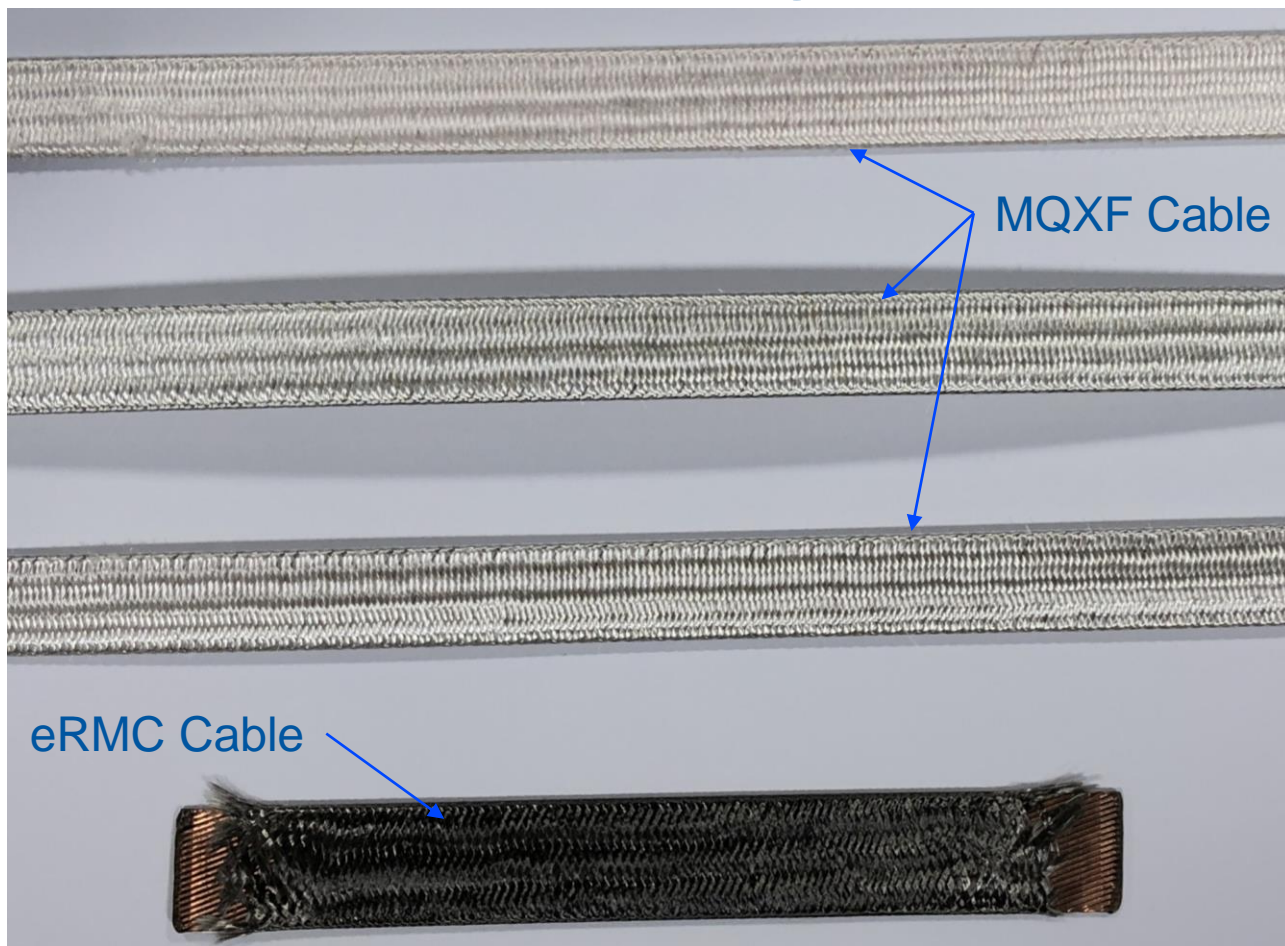
# S2 Glass Braid 933 Sizing 33 Tex

As-Received

After Thermal  
Desizing

After Thermal Desizing +  
Reaction Cycle

No Desizing,  
After Reaction



# Nb3Sn Precursor Cable – After Thermal Desizing

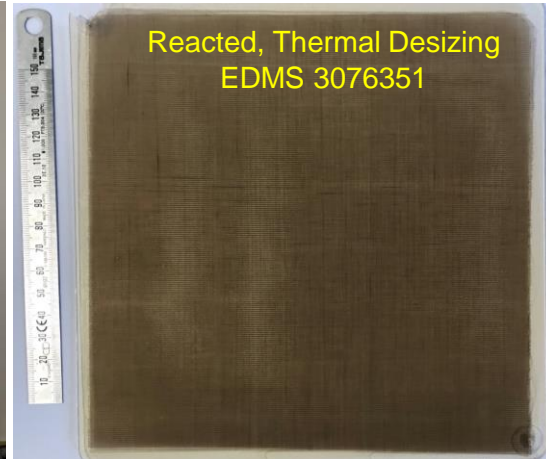
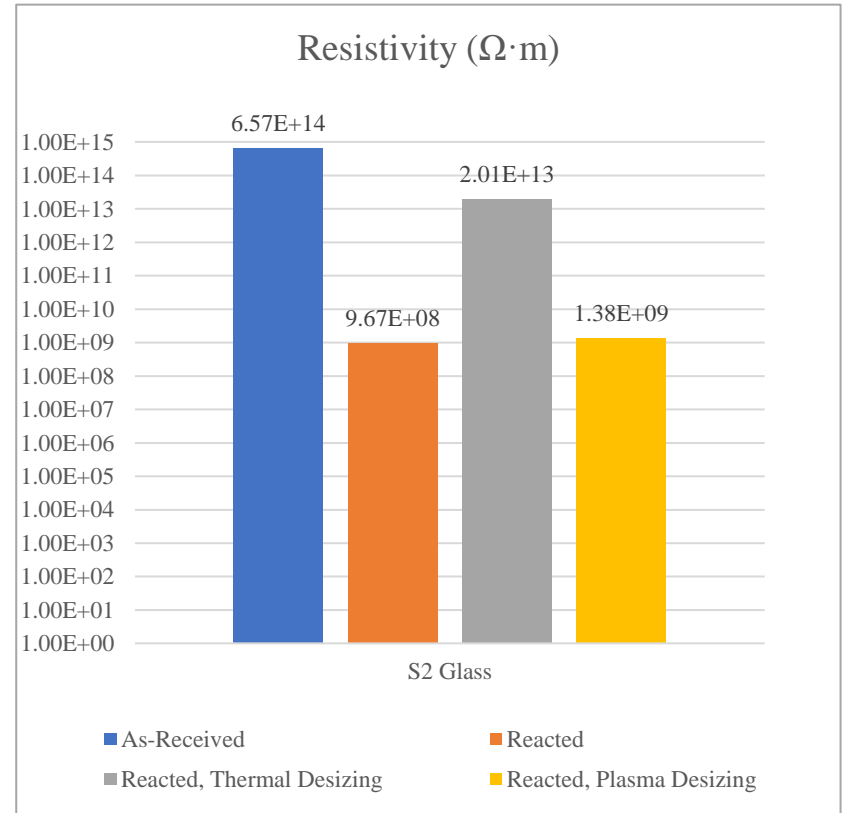
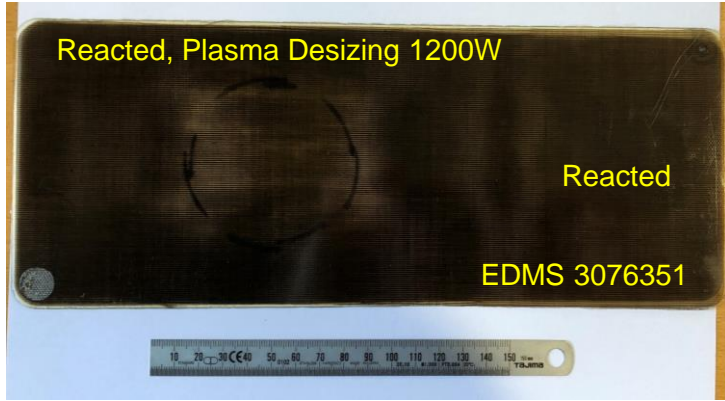
Buildup of Oxide Layer  
Resistance in k $\Omega$  range



# Nb<sub>3</sub>Sn Precursor Cable – After Thermal Desizing



# Resistivity Tests (Reports Pending)



# Conclusions and Future Work

- Thermal desizing also appears to work on quartzel (QS1318 sizing).
- Thermal desizing appears more effective on 636 sizing than 493 sizing. Thickness of the fabric may have an influence
- On S2 glass (493), a small amount of conductive residue is present after the reaction cycle, even with thermal desizing.
- This small amount of conductive residue lowers resistivity, but it remains very high (in the order of  $10^{13} \Omega \cdot \text{m}.$ ).
- The 1200W plasma desizing does not appear to be effective at preventing carbon residue formation.
- Future Work:
  - Validation of results with dielectric strength tests.
  - Impregnation and testing of S2 glass fibres with 800W plasma desizing.
  - Impregnation and testing of quartzel fibres with thermal desizing.
  - Optimization of plasma treatment parameters and preparation of plates for electrical tests (sizing 636 and 493).

Thank You

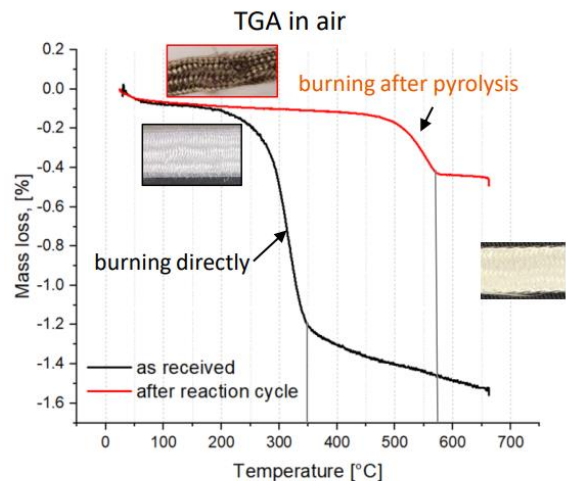
# Additional Slides

# A.Brem et al. 'Progress in materials and processes at PSI' (2023)

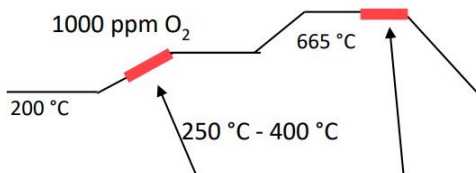
<https://indico.cern.ch/event/1302031/contributions/5587828/>

	RRR <sub>292/18</sub>	RRR reduction
Reference	532	-
250-400 °C	521	2%
665°C in vacuum	443	16%*

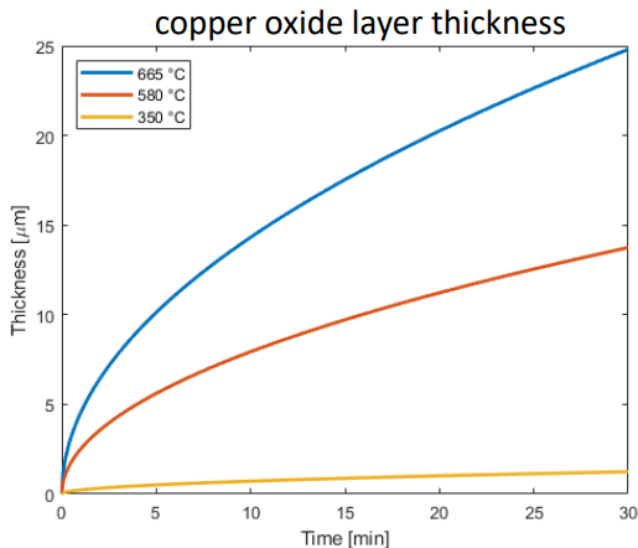
\* in line with the reduction in cross-section due to the oxide layer



TGA measurements of glass fiber braids in atmosphere at 1 °C/min.  
 As received: braid as received on the cable – no cleaning  
 After reaction cycle: braid as received after a complete reaction cycle



reference in argon      250-400 °C      665 °C in vacuum



Build up of CuO layer at various temperatures in atmosphere, calculated with a parabolic rate law,  $E_a = 92.5$  kJ/mol.

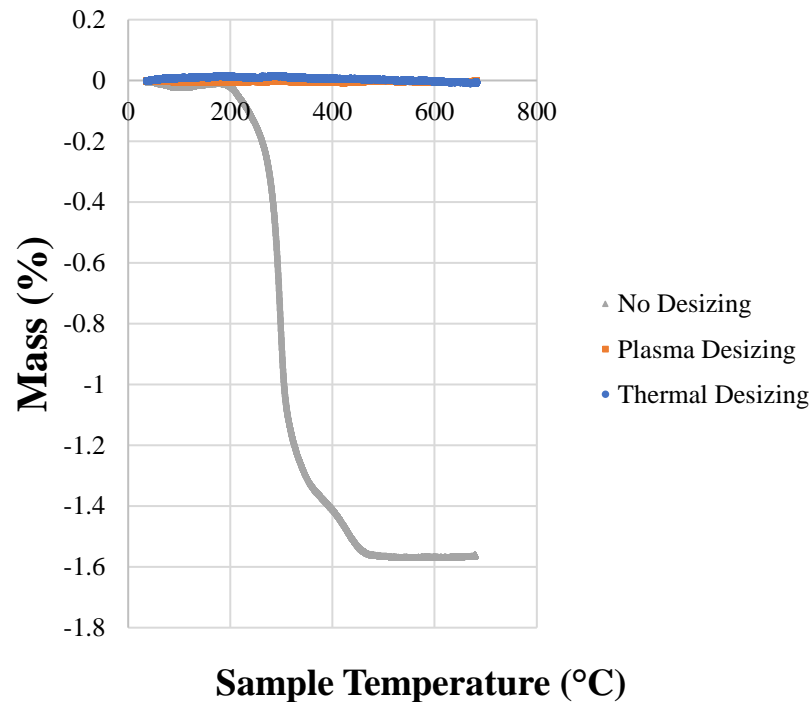


# Thermogravimetric Analysis (TGA)



- The effectiveness of a desizing process can be studied using thermogravimetric analysis (TGA).
- A known mass of sample is heated with a fixed ramp rate in a controlled atmosphere and the loss of mass is measured.
- The presence of sizing is associated with a loss in mass.
- These results indicate that both the thermal desizing and plasma desizings are adequate methods.

## TGA analysis of Desized Fibres (636) in Air (Ramp $10^{\circ}\text{Cmin}^{-1}$ )

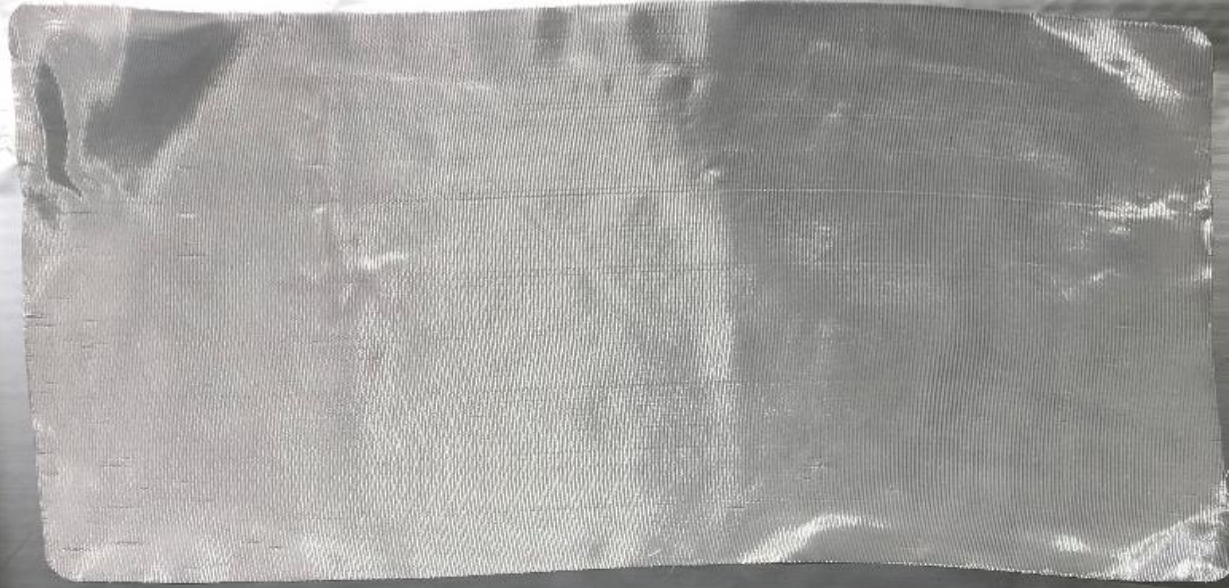


## After Thermal Desizing

S2 933 Thermal Desizing 4h 400C, Air

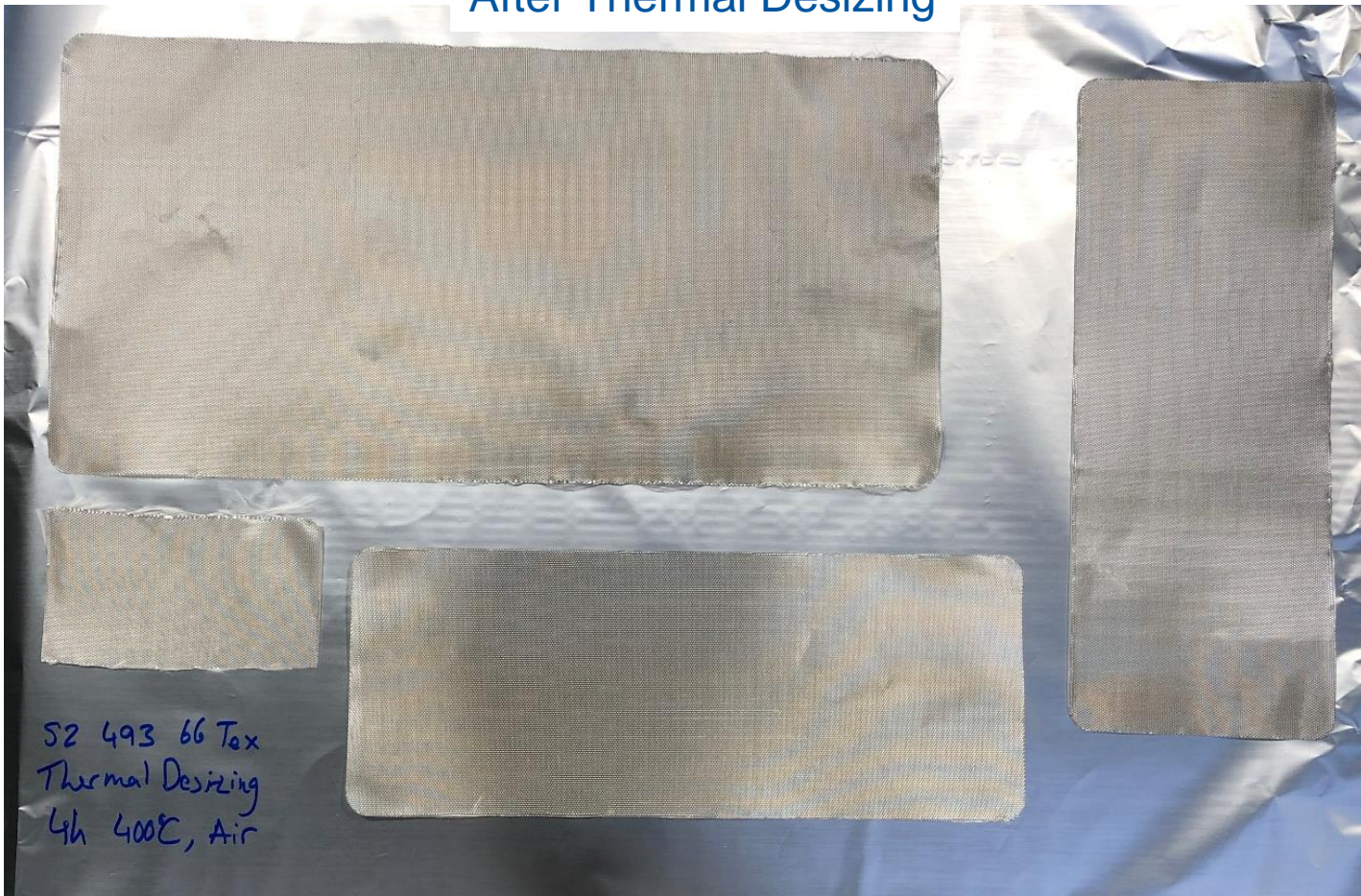


After Thermal Desizing



52 636 Thermal Desizing 4h 400°C, Air

## After Thermal Desizing



After Thermal  
Desizing

Quartzel  
Thermal Desizing  
4h 400°C, Air



# After Nb<sub>3</sub>Sn Reaction Cycle

